Silicon Labs (NASDAQ: SLAB) is a leader in secure, intelligent wireless technology for a more connected world.

- Focus on large & growing markets
- Robust breadth and depth of protocols & ecosystems
- Strong & sustainable growth, highly attractive target model
- Channel revenue ~80% of total revenue

Headquartered in Austin, Texas, with ~1,800 employees, creating a global perspective that is an integral part of our culture.

For complete information regarding Silicon Labs' financial results, please visit https://investor.silabs.com
Integrated hardware and software platform – supporting more wireless protocols than anyone in the industry – for industrial, commercial, home and life applications, reaching tens of thousands of global customers

**Recent Business Highlights**

In Q2 2023, Silicon Labs held the grand opening of the Silicon Labs Connectivity Lab in our Boston site, an event attended by top customers and partners. The Connectivity Lab simulates a modern Smart Home, with a range of IoT devices, applications, ecosystems, and networks. It offers developers an ideal environment to test their Matter prototypes.

In Q3 2023, Silicon Labs hosted its fourth annual Works With Conference in August, which attracted thousands of top IoT developers, and included panels with partners from Amazon, Google, Samsung, and many more.

In Q4 2023, Silicon Labs was selected as an honoree in the Embedded Technologies category at the CES 2024 Innovation Awards for its SiWx917 SoC. The x917 is the first Wi-Fi 6 combo chip in the Silicon Labs portfolio and is a Matter-ready, fully integrated single-chip solution with industry-leading low power consumption, ideal for secure cloud connectivity.

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**For more information:** Thomas Haws, Investor Relations | investor.relations@silabs.com

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Finalized the previously announced redemption process on its 2025 convertible notes. The company funded the $535 million par value of the notes in cash. The in-the-money component of the converted notes was settled with the issuance of approximately 0.9 million shares.

Announced the new dual-band FG28 SoC, designed for long-range networks and protocols like Amazon Sidewalk, Wi-SUN, and other proprietary protocols. The FG28 includes radios for sub-Gigahertz (Ghz) and 2.4 Ghz Bluetooth LE, making it particularly attractive for edge applications in growth areas like smart agriculture, smart cities, and neighborhood networks. The built-in AI/ML accelerator is a first for a sub-Ghz SoC, bringing AI/ML to the edge.

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Announced its next-generation Series 3 platform, purpose-built for embedded IoT devices. Series 3 devices will be designed to offer industry-leading compute, wireless performance, scalability, and energy efficiency with the highest levels of IoT security. New levels of compute will bring more than 100X the processing capability of Series 2 and will include integrated AI/ML accelerators for edge devices, enabling consolidation of system processing into wireless SoCs.

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In Q1 2024, Silicon Labs announced several key leadership appointments, underscoring the company’s commitment to aggressively scaling and leveraging the expertise of executives seasoned in leading high-growth transformations.

- **Dean Butler** will join the company as Senior Vice President and Chief Financial Officer (CFO) on May 15, 2024.
- **Bob Conrad** will join the company as its Senior Vice President of Worldwide Operations on April 29, 2024. Conrad transitions from his current role serving on Silicon Labs’ Board of Directors.
- **Radhika Chennakeshavula** joins Silicon Labs as Chief Information Officer (CIO) on April 24, 2024.

Announced Silicon Labs’ highest-performance device family to date, the xG26 family of wireless SoCs and MCUs. The xG26 family is designed to future-proof the IoT against some of the most demanding emerging applications, including Matter, with double the flash, RAM, and general-purpose input/output capacity as the xG24 family, as well as higher performance compute, embedded AI/ML acceleration, industry-leading power efficiency and security, and 2.4 GHz wireless connectivity that supports Matter, Zigbee, OpenThread, Bluetooth Low Energy, Bluetooth Mesh, Proprietary, and multihop.